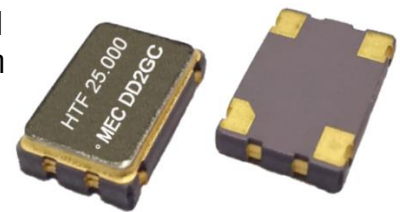




QHTF is one of the Mercury QuikXO family quick-turn CMOS output clock oscillators. QuikXO™ products, either standard or custom frequencies are built-to-order and shipped from California USA in 3 to 5 days. QHTF is available in five different hermetically sealed ceramic leadless SMD packages and three supply Voltage, covers frequency range from 1.0 MHz to 200 MHz. Pin 1 can be either Tri-State high enable or power down.



General Specifications: at Ta= +25°C

Product Series	QHTF Series				
Output Logic Type	CMOS (code "T")				
HTF Series Models	QHTF21	QHTF22	QHTF32	QHTF53	QHTF57
Package Dimensions (mm)	2.0x1.6x0.8	2.5x2.0x0.8	3.2x2.5x1.0	5.0x3.2x1.2	7.0x5.0x1.3

Supply Voltage (V _{DD})	+1.8 V ±5%		+2.5 V ±10%		+3.3 V ±10%			
	Voltage Code: "18"		Voltage Code: "25"		Voltage Code: "3"			
Frequency Range	1.0 ~ 125.0 MHz		1.0 ~ 200.0 MHz		1.0 ~ 200.0 MHz			
Current Consumption	20 mA typical 30 mA max.		28 mA typical 35 mA max.		30 mA typical 40 mA max.			
Rise / Fall Time (Tr; Tf) 10% ↔ 90% waveform. 15 pF load.	2.0 n. sec. typical 5.0 n. sec. max.		1.4 n. sec. typical 3.0 n. sec. max.		1.1 n. sec. typical 3.0 n. sec. max.			
Frequency Stability	±50 ppm over -40 to +85°C. Spec.							
Aging at Ta= +25°C	±3 ppm (max.) the first year; ±2 ppm (max.) per year thereafter							
Output Load	15 pF typical							
Output Drive Strength	8 mA typical							
Output High Voltage; V _{OH}	V _{DD} – 0.4 V min.							
Output Low Voltage; V _{OL}	0.4V max.							
Duty Cycle	1.0~150.0 MHz: 50% ±5%. 150.01~200.0 MHz: 50% ±10%. At V _{DD} /2.							
Start-up Time	4.5 m. sec. typical; 10 m. sec. max.							
Pin 1 Option: Output Enable (OE) / Disable								
Output Enable / Disable	70% of V _{DD} (min.) to Enable; 30% of V _{DD} (max.) to Disable							
Output Enable Time	10 n. sec. max. High Enable. Pin 1 option code: OE							
Output Disable Current	18 mA typical; 22 mA max.							
Pin 1 Option: Output Power Down (PD)								
Output Enable / Disable	70% of V _{DD} (min.) to Enable; 30% of V _{DD} (max.) to Disable							
Output Enable Time	4.5 m. sec. typical. 10 m. sec. max. Pin 1 option code: PD							
Output Enable / Disable	300 μA typical; 400 μA max.							
	Offset	10 Hz	100 Hz	1 kHz	10 kHz	100 kHz	1 MHz	10 MHz



MERCURY www.mercury-crystal.com

Taiwan: TEL (886)-2-2406-2779, e-mail: sales-tw@mercury-crystal.com

U.S.A.: TEL (1)-909-466-0427, e-mail: sales-us@MercuryUnited.com

Single Sideband Phase Noise (dBc / Hz; typical)	dBc / Hz	-61	-89	-110	-119	-119	-142	-149
Integrated Phase Jitter, RMS, 12 kHz to 20 MHz		3.3 V: 1.0 p. sec. typical; 2.5 V: 1.1 p. sec. typical; 1.8 V: 1.5 p. sec. typical						

Absolute Maximum Rating:

Positive Supply Voltage (V_{DD})	-0.5 V ~ 7 V w.r.t. ground
Input Pin Voltage (V_{in})	-0.5 V to V _{DD} +0.5 V
Output Pin Voltage (V_{out})	-0.5 V to V _{DD} +0.5 V
Electrostatic Discharge (ESD)	Human Body Model (HBM): Exceeds 2000 V. Class 2 per MIL-STD-1686C
	Machine Model (MM): Exceeds 120 V. Class M2 per MIL-STD-1686C. Note: Power, ground, and outputs are 200 V.
	Charged-Device Model (CDM): Exceeds 2000 V. Class C6 per MIL-STD-1686C

Environmental Performance Specifications

Green Requirement	RoHS compliant, Pb (lead) free per EU Directive 2002/95/EC 6/6 (2002/95/EC) and WEEE (2002/96/EC). Free of halide, cadmium, hexavalent chromium, lead, mercury, PBB's, and PBDE's.
Moisture Sensitivity Level	Level 1 per IPC/JEDEC J-STD-020D.1
Storage temperature range	-55 to +125°C
Humidity	85% RH, 85°C, 48 hours
Fine Leak / Gross Leak	MIL-Std-883, method 1014, condition A / MIL-Std-883, method 1014, condition C
Solderability	MIL-STD-202F method 208E
Reflow	260°C for 10 sec. 2X.
Vibration	MIL-STD-202F method 204, 35G, 50 to 2000 Hz
Shock	MIL-STD-202F method 213B, test condition. E, 1000GG ½ sine wave
Resistance to Solvent	MIL-STD-202, method 215
Temperature Cycling	MIL-STD-883, method 1010
Pad Surface Finish	Gold (0.3 um to 1.0 um) over nickel (1.27 um to 8.89 um)

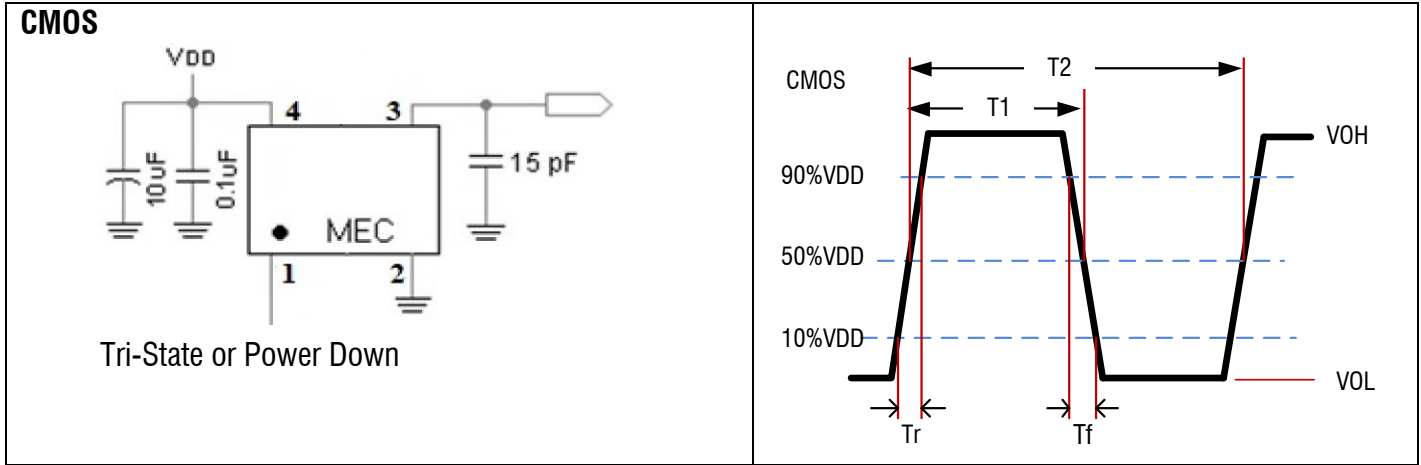
Part Number Format and Examples:

Example 1: 18QHTF57-25.000-PD Example 2: 25QHTF53-100.000-OE Example 3: 3QHTF32-200.000-PD

18	QHTF	57	-	25.000	-	PD
25		53		100.000		OE
3		32		200.000		PD
Voltage Code "18" for 1.8V "25" for 2.5V "3" for 3.3V	HTF Series	Package Code "57": 7.0x5.0x1.3 mm "53": 5.0x3.2x1.2 mm "32": 3.2x2.5x1.0 mm "22": 2.5x2.0x0.8 mm "21": 2.0x1.6x0.8 mm	a dash	The nominal Frequency in MHz. 3 places or more after the decimal point	a dash	Pin 1 option: "PD": Power Down "OE": Output Enable

Test Circuits and Output Waveforms

Duty cycle = $\left(\frac{T1}{T2}\right) * 100\%$. Measured at 50% V_{DD}

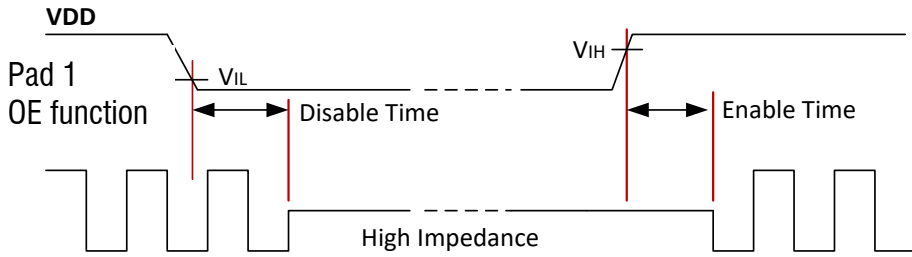


Package Dimensions and Recommended Solder Pad Layout

unit: (mm)

<p>QHTF21</p>	<p>QHTF21</p>
<p>QHTF32</p>	<p>QHTF53</p>
<p>QHTF57</p>	<ul style="list-style-type: none"> ◆ To minimize EMI, a 10 to 100 Ω series resistor is recommended at the output signal. ◆ To improve noise immunity: Do not float pin 1. Connect it to V_{DD}, if Tri-state or power down is not used.

Output OE Function on pad 1 Note: Do not leave this pad floating. If “no-connection” is desired, please contact Mercury.



Related Products:

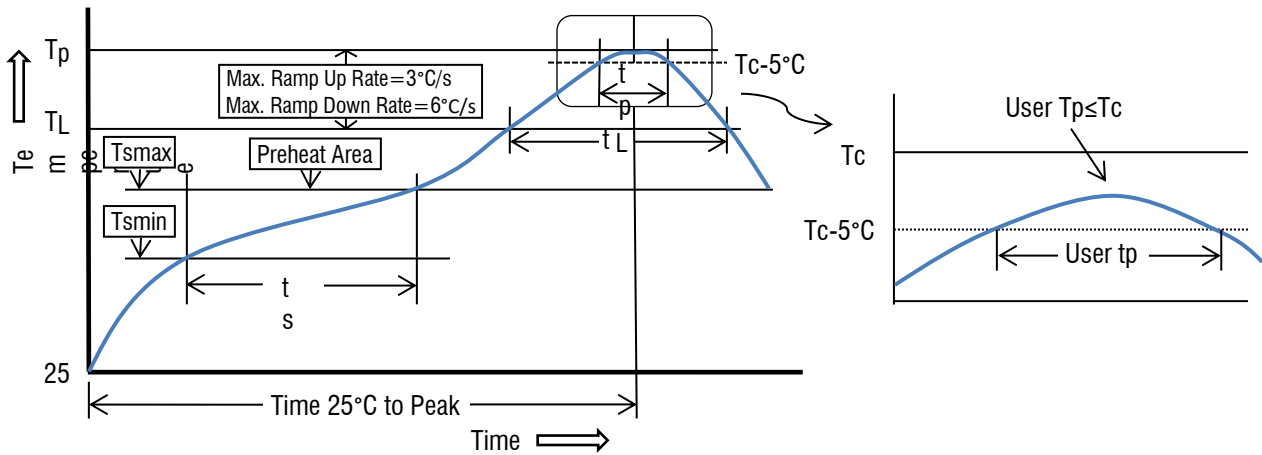
QHTF series is the QuikXO (quick turn) equivalent to the **HTF** (click to view) series, they are manufactured at different Mercury facilities using the identical designs, raw materials and production processes. Once either one is approved, Mercury recommends to include both the **QuikXO** and the **non-QuikXO** part numbers of your referenced part on your BOM to take advantage of the **QuikXO** short lead- times and the **non-QuikXO** low-cost high-volume production offerings.

E.g. 1, if the **QuikXO** 18QHTF57-25.000-PD oscillator is qualified, then the **non-QuikXO** 18HTF57-ET-25.000-PD should also be on the same BOM.

E.g. 2, if the **QuikXO** 25QHTF53-100.000-OE oscillator is qualified, then the **non-QuikXO** 25HTF53-ET-100.000-OE should also be on the same BOM.

E.g. 3, if the **QuikXO** 3QHTF32-200.000-PD oscillator is qualified, then the **non-QuikXO** 3HTF57-ET-200.000-PD should also be on the same BOM.

Recommended Solder Reflow Profile (per IPC/JEDEC J-STD-020D.1)



Profile Feature	Sn-Pb Eutectic Assembly	Pb-free Assembly
Preheat/Soak		
- Temperature min. (Ts min.)	100°C	150°C
- Temperature max. (Ts max.)	150°C	200°C
- Time (ts) (Ts min. to Ts max.)	60 to 120 seconds	60 to 180 seconds
Ramp-up rate (TL to Tp)	3°C / sec. max.	3°C / sec. max.
Liquidous temperature (TL)	183°C	217°C
Time (tL) maintained above TL	60 to 150 seconds	60 to 150 seconds
Peak package body temperature (Tp)	235°C	260°C
Time (Tp) within 5°C of the classification temperature Tc	10 to 30 seconds	20 to 40 seconds
Ramp-down rate (Tp to TL)	6°C / second max.	6°C / second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

All temperatures refer to the topside of the package, measured on the package body surface.